TABLE 1

<table>
<thead>
<tr>
<th>Variant</th>
<th>Label text</th>
</tr>
</thead>
<tbody>
<tr>
<td>001</td>
<td>bq50002 + bq500511</td>
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</tbody>
</table>

Components marked 'DNP' should not be populated.

Assembly variant: 001

PCB VIEWED FROM TOP SIDE

<table>
<thead>
<tr>
<th>Ignore -&gt;</th>
<th>Top Overlay</th>
</tr>
</thead>
</table>

Plot Name = Top Assembly Drawing

Generated: 11/18/2015 2:58:31 PM

Texas Instruments
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

<table>
<thead>
<tr>
<th>PCB VIEWED FROM BOTTOM SIDE</th>
<th>BOARD #: TIDA-00762</th>
<th>REV: E1</th>
<th>SUN REV: Not In VersionControl</th>
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</thead>
<tbody>
<tr>
<td></td>
<td></td>
<td>IGNORE</td>
<td>Bottom Overlay</td>
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<tr>
<td>PLOT NAME = Bottom Assembly Drawing</td>
<td>GENERATED : 11/18/2015 2:58:32 PM</td>
<td>TEXAS INSTRUMENTS</td>
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